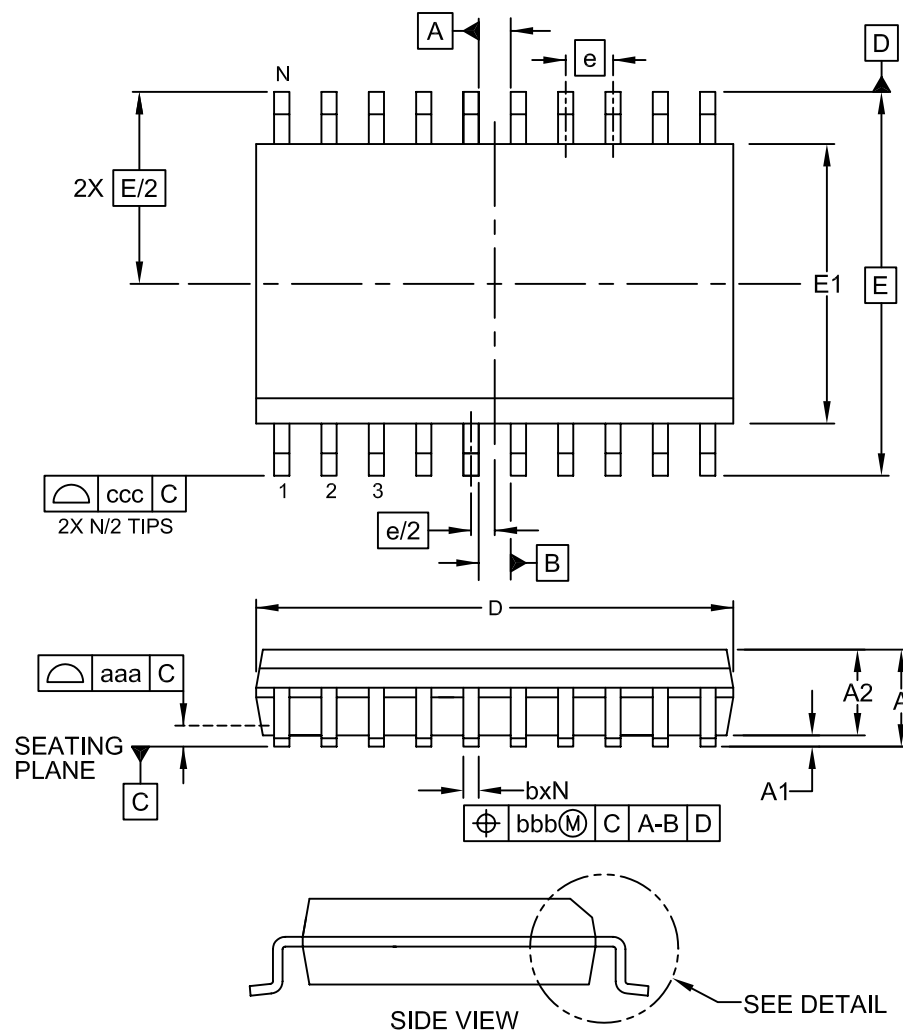


REVISIONS

REV	DESCRIPTION	DATE	APPR.
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DIM	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	.093	-	.104	2.35	-	2.65
A1	.004	-	.012	0.10	-	0.30
A2	.081	-	.100	2.05	-	2.55
b	.012	-	.020	0.31	-	0.51
c	.008	-	.013	0.20	-	0.33
D	.500	.504	.508	12.70	12.80	12.90
E1	.291	.295	.299	7.40	7.50	7.60
E	.406 BSC			10.30 BSC		
e	.050 BSC			1.27 BSC		
h	.010	-	.030	0.25	-	0.75
L	.016	-	.041	0.40	-	1.04
L1	(.041)			(1.04)		
N	20			20		
theta1	0°	-	8°	0°	-	8°
aaa	.004			0.10		
bbb	.010			0.25		
ccc	.013			0.33		

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. DATUMS **-A-** AND **-B-** TO BE DETERMINED AT DATUM PLANE **-H-**
3. DIMENSIONS "E1" AND "D" DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
4. REFERENCE JEDEC STD MS-013, VARIATION AC.



DRAWN: L. NICHOLAS		TITLE: PACKAGE OUTLINE DRAWING SOIC, 20 LEAD	
CHKD: TOM GREENSMITH		DRAWING NO: LNIS-68KN7B	
REF DWG: JEDEC MS-013, AC			
DATE: 01/11/05	SCALE: N/A	REV: 1	